## **Driver Transistors**

## **PNP Silicon**

#### **Features**

• These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### **MAXIMUM RATINGS**

Rating		Symbol	Value	Unit
Collector - Emitter Voltage	MMBTA55 MMBTA56	V <sub>CEO</sub>	-60 -80	Vdc
Collector - Base Voltage	MMBTA55 MMBTA56	V <sub>CBO</sub>	-60 -80	Vdc
Emitter - Base Voltage		$V_{EBO}$	-4.0	Vdc
Collector Current - Continuou	ıs	I <sub>C</sub>	-500	mAdc

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

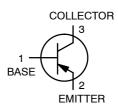
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.
- 2. Alumina =  $0.4 \times 0.3 \times 0.024$  in. 99.5% alumina.



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SOT-23 CASE 318 STYLE 6

## **MARKING DIAGRAM**



2xx = Device Code

x = H for MMBTA55LT1

xx = GM for MMBTA56LT1

M = Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

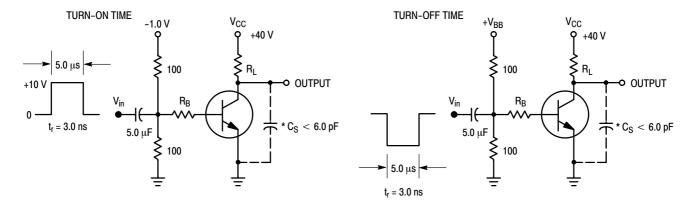
#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (Note 3) $(I_C = -1.0 \text{ mAdc}, I_B = 0)$	MMBTA55 MMBTA56	V <sub>(BR)CEO</sub>	-60 -80	- -	Vdc
Emitter – Base Breakdown Voltage $(I_E = -100 \mu Adc, I_C = 0)$		V <sub>(BR)EBO</sub>	-4.0	-	Vdc
Collector Cutoff Current (V <sub>CE</sub> = -60 Vdc, I <sub>B</sub> = 0)		I <sub>CES</sub>	-	-0.1	μAdc
Collector Cutoff Current $(V_{CB} = -60 \text{ Vdc}, I_E = 0)$ $(V_{CB} = -80 \text{ Vdc}, I_E = 0)$	MMBTA55 MMBTA56	I <sub>CBO</sub>	- -	-0.1 -0.1	μAdc
ON CHARACTERISTICS					
DC Current Gain $ \begin{aligned} (I_C = -10 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}) \\ (I_C = -100 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}) \end{aligned} $		h <sub>FE</sub>	100 100	- -	-
Collector – Emitter Saturation Voltage (I <sub>C</sub> = -100 mAdc, I <sub>B</sub> = -10 mAdc)		V <sub>CE(sat)</sub>	_	-0.25	Vdc
Base – Emitter On Voltage ( $I_C = -100 \text{ mAdc}$ , $V_{CE} = -1.0 \text{ Vdc}$ )		V <sub>BE(on)</sub>	-	-1.2	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current – Gain – Bandwidth Product (Note 4) $(I_C = -100 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}, f = 100 \text{ MHz})$		f <sub>T</sub>	50	-	MHz

<sup>3.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



\*Total Shunt Capacitance of Test Jig and Connectors For PNP Test Circuits, Reverse All Voltage Polarities

Figure 1. Switching Time Test Circuits

<sup>4.</sup>  $f_T$  is defined as the frequency at which  $|h_{fe}|$  extrapolates to unity.

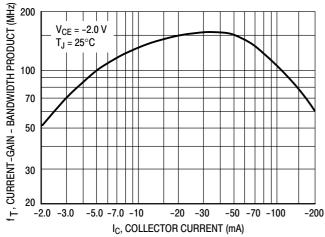


Figure 2. Current-Gain — Bandwidth Product

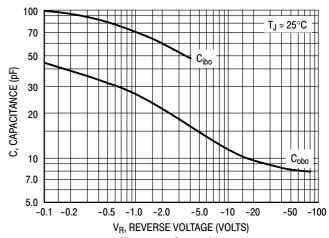


Figure 3. Capacitance

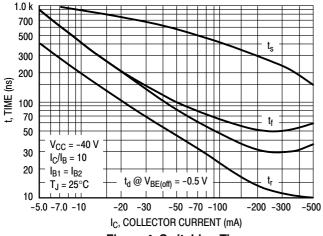


Figure 4. Switching Time

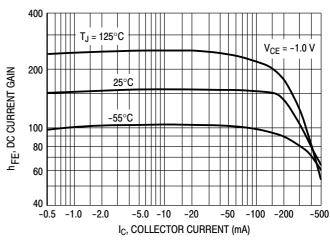


Figure 5. DC Current Gain

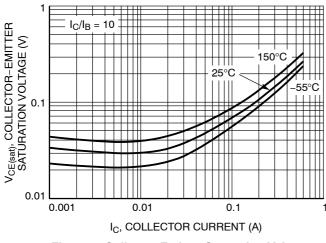


Figure 6. Collector Emitter Saturation Voltage vs. Collector Current

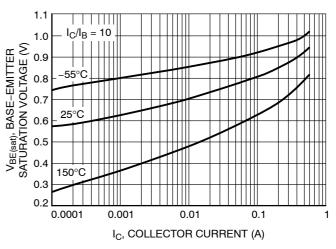


Figure 7. Base Emitter Saturation Voltage vs.
Collector Current

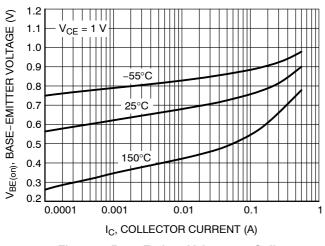


Figure 8. Base Emitter Voltage vs. Collector Current

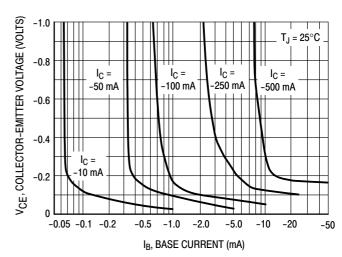


Figure 9. Collector Saturation Region

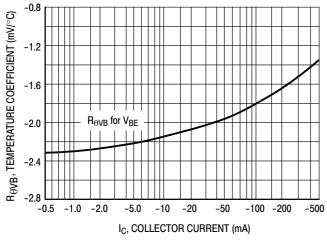


Figure 10. Base–Emitter Temperature Coefficient

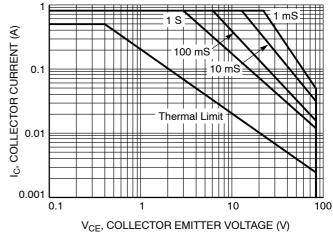


Figure 11. Safe Operating Area

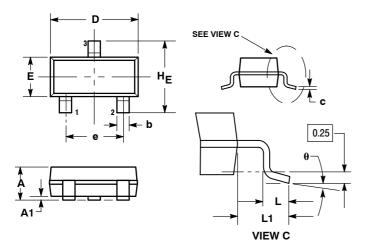
## **ORDERING INFORMATION**

Device Order Number	Package Type	Shipping <sup>†</sup>	
MMBTA55LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel	
MMBTA55LT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel	
MMBTA56LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel	
MMBTA56LT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AN



#### NOTES:

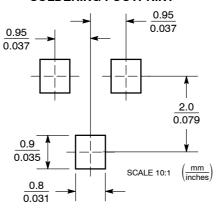
- DIMENSIONING AND TOLERANCING PER ANSI
   V14 FM 1082
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS, MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL
- 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

#### STYLE 6:

- PIN 1. BASE 2. EMITTER
  - 3. COLLECTOR

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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